

INTERNATIONAL STANDARD

NORME INTERNATIONALE



**Surface acoustic wave (SAW) and bulk acoustic wave (BAW) duplexers of assessed quality –
Part 1: Generic specification**

**Duplexeurs à ondes acoustiques de surface (OAS) et à ondes acoustiques de volume (OAV) sous assurance de la qualité –
Partie 1: Spécification générique**



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INTERNATIONAL ELECTROTECHNICAL COMMISSION

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BULK ACOUSTIC WAVE (BAW) DUPLEXERS
OF ASSESSED QUALITY –****Part 1: Generic specification****FOREWORD**

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IEC 62604-1 has been prepared by IEC technical committee 49: Piezoelectric, dielectric and electrostatic devices and associated materials for frequency control, selection and detection. It is an International Standard.

This second edition cancels and replaces the first edition published in 2015. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- the term "multiplexer" has been added to Clause 3.

NOTE In this document, SAW and BAW duplexers are treated simultaneously because both duplexers are used in the same manner especially in mobile phones and have the same requirements of characteristics, test method and so on.

The text of this International Standard is based on the following documents:

Draft	Report on voting
49/1360/CDV	49/1375/RVC

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at www.iec.ch/members_experts/refdocs. The main document types developed by IEC are described in greater detail at www.iec.ch/publications.

A list of all parts in the IEC 62604 series, published under the general title *Surface acoustic wave (SAW) and bulk acoustic wave (BAW) duplexers of assessed quality*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under webstore.iec.ch in the data related to the specific document. At this date, the document will be

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SURFACE ACOUSTIC WAVE (SAW) AND BULK ACOUSTIC WAVE (BAW) DUPLEXERS OF ASSESSED QUALITY –

Part 1: Generic specification

1 Scope

This part of IEC 62604 specifies the methods of test and general requirements for SAW and BAW duplexers of assessed quality using either capability approval or qualification approval procedures.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60027 (all parts), *Letter symbols to be used in electrical technology*

IEC 60050-561, *International electrotechnical vocabulary – Part 561: Piezoelectric, dielectric and electrostatic devices and associated materials for frequency control, selection and detection*

IEC 60068-1:2013, *Environmental testing – Part 1: General and guidance*

IEC 60068-2-1, *Environmental testing – Part 2-1: Tests – Test A: Cold*

IEC 60068-2-2, *Environmental testing – Part 2-2: Tests – Test B: Dry heat*

IEC 60068-2-6, *Environmental testing – Part 2-6: Tests – Test Fc: Vibration (sinusoidal)*

IEC 60068-2-7, *Basic environmental testing procedures – Part 2-7: Tests – Test Ga and guidance: Acceleration, steady state*

IEC 60068-2-13, *Basic environmental testing procedures – Part 2-13: Tests – Test M: Low air pressure*

IEC 60068-2-14, *Environmental testing – Part 2-14: Tests – Test N: Change of temperature*

IEC 60068-2-17:1994, *Basic environmental testing procedures – Part 2-17: Tests – Test Q: Sealing*

IEC 60068-2-27, *Environmental testing – Part 2-27: Tests – Test Ea and guidance: Shock*

IEC 60068-2-30, *Environmental testing – Part 2-30: Tests – Test Db: Damp heat, cyclic (12 h + 12 h cycle)*

IEC 60068-2-31, *Environmental testing – Part 2-31: Tests – Test Ec: Rough handling shocks, primarily for equipment-type specimens*

IEC 60068-2-45, *Basic environmental testing procedures – Part 2-45: Tests – Test XA and guidance: Immersion in cleaning solvents*

IEC 60068-2-52, *Environmental testing – Part 2-52: Tests – Test Kb: Salt mist, cyclic (sodium chloride solution)*

IEC 60068-2-58, *Environmental testing – Part 2-58: Tests – Test Td: Test methods for solderability, resistance to dissolution of metallization and to soldering heat of surface mounting devices (SMD)*

IEC 60068-2-64, *Environmental testing – Part 2-64: Tests – Test Fh: Vibration, broadband random and guidance*

IEC 60068-2-78, *Environmental testing – Part 2-78: Tests – Test Cab: Damp heat, steady state*

IEC 60122-1, *Quartz crystal units of assessed quality – Part 1: Generic specification*

IEC 60617, *Graphical symbols for diagrams* (available at <http://std.iec.ch/iec60617>)

IEC 60642, *Piezoelectric ceramic resonators and resonator units for frequency control and selection – Chapter I: Standard values and conditions – Chapter II: Measuring and test conditions*

IEC 60695-11-5, *Fire hazard testing – Part 11-5: Test flames – Needle-flame test method – Apparatus, confirmatory test arrangement and guidance*

IEC 60749-28, *Semiconductor devices – Mechanical and climatic test methods – Part 28: Electrostatic discharge (ESD) sensitivity testing – Charged device model (CDM) – device level*

IEC 61000-4-2, *Electromagnetic compatibility (EMC) – Part 4-2: Testing and measurement techniques – Electrostatic discharge immunity test*

IEC 61340-3-1¹, *Electrostatics – Part 3-1: Methods for simulation of electrostatic effects – Human body model (HBM) electrostatic discharge test waveforms*

IEC 61340-3-2¹, *Electrostatics – Part 3-2: Methods for simulation of electrostatic effects – Machine model (MM) electrostatic discharge test waveforms*

IEC 62761, *Guidelines for the measurement method of nonlinearity for surface acoustic wave (SAW) and bulk acoustic wave (BAW) devices in radio frequency (RF)*

IEC 80000 (all parts), *Quantities and units*

ISO 80000 (all parts), *Quantities and units*

3 Terms, definitions, units and graphical symbols

3.1 Terms and definitions

For the purposes of this document, the following terms and definitions apply.

¹ Withdrawn

ISO and IEC maintain terminology databases for use in standardization at the following addresses:

- IEC Electropedia: available at <http://www.electropedia.org/>
- ISO Online browsing platform: available at <http://www.iso.org/obp>

3.1.1 General terms

3.1.1.1

surface acoustic wave

SAW

acoustic wave, propagating along a surface of an elastic material, whose amplitude decays exponentially with the depth

[SOURCE: IEC 60862-1:2015, 3.1.1.1]

3.1.1.2

surface acoustic wave filter

SAW filter

filter characterized by one or more surface acoustic wave transmission line or resonant elements, where the surface acoustic wave is usually generated by an interdigital transducer and propagates along a material surface

[SOURCE: IEC 60862-1:2015, 3.1.1.2]

3.1.1.3

bulk acoustic wave

BAW

acoustic wave, propagating inside an elastic material and then traversing the entire thickness of the bulk

Note 1 to entry: The wave is excited by metal electrodes attached to both sides of the piezoelectric layer.

3.1.1.4

bulk acoustic wave filter

BAW filter

filter characterized by a bulk acoustic wave which is usually generated by a pair of electrodes and propagates along a thickness direction

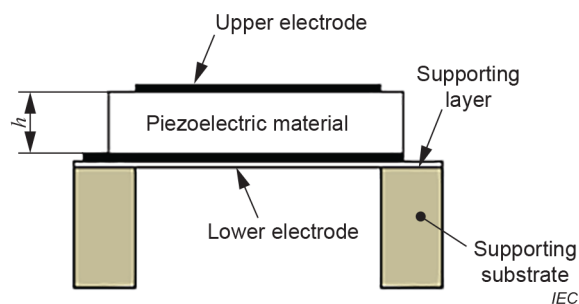
3.1.1.5

film bulk acoustic resonator

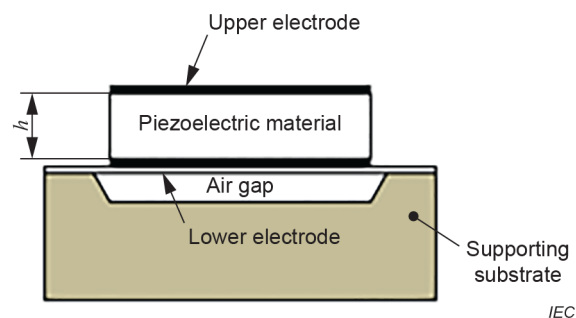
FBAR

thin film BAW resonator consisting of a piezoelectric layer sandwiched between two electrode layers with stress-free top and bottom surface supported mechanically at the edge on a substrate with cavity structure as shown in Figure 1 or membrane structure as an example

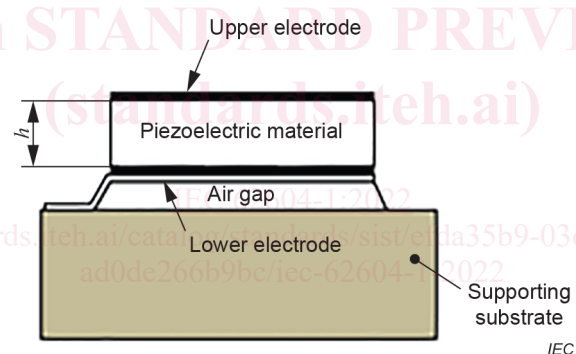
Note 1 to entry: This note applies to the French language only.



a) – Back-side etched



b) – Front-side etched



c) – Sacrificial-layer etched

Figure 1 – FBAR configuration

3.1.1.6

solidly mounted resonator

SMR

BAW resonator, supporting the electrode/piezoelectric layer/electrode structure by a sequence of additional thin films of alternately low and high acoustic impedance Z_a with quarter wavelength layer, and these layers act as acoustic reflectors and decouple the resonator acoustically from the substrate, as shown in Figure 2 as an example

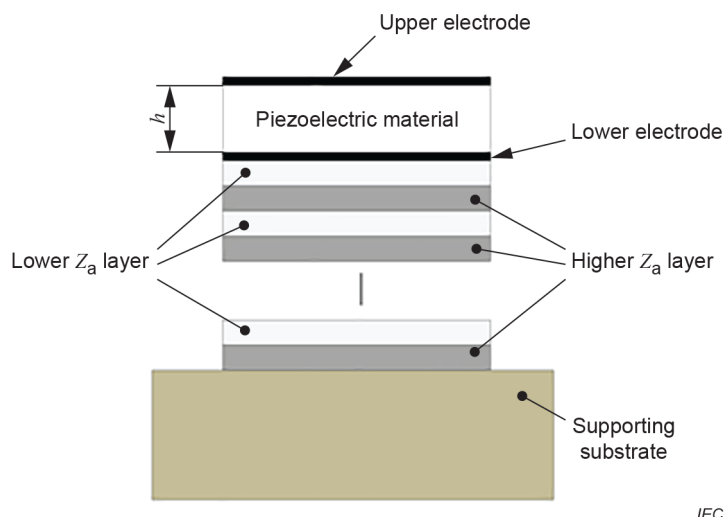


Figure 2 – SMR configuration

3.1.2 Response characteristics related terms

3.1.2.1

reference frequency

frequency defined by the specification to which other frequencies may be referred

[SOURCE: IEC 60862-1:2015, 3.1.2.3]

3.1.2.2

insertion attenuation

logarithmic ratio of the power delivered directly to the load impedance before insertion of the duplexer to the power delivered to the load impedance after insertion of the duplexer

[SOURCE: IEC 60862-1:2015, 3.1.2.6, modified – In the definition, "filter" has been replaced with "duplexer".]

3.1.2.3

nominal insertion attenuation

insertion attenuation at a specified reference frequency

[SOURCE: IEC 60862-1:2015, 3.1.2.7]

3.1.2.4

relative attenuation

difference between the attenuation at a given frequency and the attenuation at the reference frequency

[SOURCE: IEC 60862-1:2015, 3.1.2.8]

3.1.2.5

pass band

band of frequencies in which the relative attenuation is equal to or less than a specified value

[SOURCE: IEC 60862-1:2015, 3.1.2.9]

3.1.2.6

pass bandwidth

separation of frequencies between which the relative attenuation is equal to or less than a specified value

[SOURCE: IEC 60862-1:2015, 3.1.2.10]

3.1.2.7

pass band ripple

maximum variation in attenuation characteristics within a specified pass band

[SOURCE: IEC 60862-1:2015, 3.1.2.11]

3.1.2.8

minimum insertion attenuation

minimum value of insertion attenuation in the pass band

[SOURCE: IEC 60862-1:2015, 3.1.2.13]

3.1.2.9

maximum insertion attenuation

maximum value of insertion attenuation in the pass band

[SOURCE: IEC 60862-1:2015, 3.1.2.14]

3.1.2.10

stop band

band of frequencies in which the relative attenuation is equal to or greater than a specified value

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[SOURCE: IEC 60862-1:2015, 3.1.2.15]

3.1.2.11

stop bandwidth

separation of frequencies between which the relative attenuation is equal to or greater than a specified value

[SOURCE: IEC 60862-1:2015, 3.1.2.16]

3.1.2.12

stop band rejection

minimum relative attenuation at a specified stop band

[SOURCE: IEC 60862-1:2015, 3.1.2.17]

3.1.2.13

group delay

time equal to the first derivative of the phase shift, in radians, with respect to the angular frequency

[SOURCE: IEC 60862-1:2015, 3.1.2.19]

3.1.2.14

trap frequency

specified frequency at which the relative attenuation is equal to or greater than a specified value

[SOURCE: IEC 60862-1:2015, 3.1.2.22]

3.1.2.15

trap attenuation

relative attenuation at a specified trap frequency

[SOURCE: IEC 60862-1:2015, 3.1.2.23]

3.1.2.16

transition band

band of frequencies between the cut-off frequency and the nearest point of the adjacent stop band

[SOURCE: IEC 60862-1:2015, 3.1.2.24]

3.1.2.17

reflectivity

dimensionless measure of the degree of mismatch between two impedances Z_a and Z_b :

$$\frac{Z_a - Z_b}{Z_a + Z_b},$$

where Z_a and Z_b represent, respectively, the input and source impedance or the output and load impedance

Note 1 to entry: The absolute value of reflectivity is called the reflection coefficient.

[SOURCE: IEC 60862-1:2015, 3.1.2.25]

3.1.2.18

return attenuation

value of the reflection coefficient given by the sign changed expression in decibels:

$$-20 \log \left| \frac{Z_a - Z_b}{Z_a + Z_b} \right| \text{ dB}$$

[SOURCE: IEC 60862-1:2015, 3.1.2.26]

3.1.2.19

input level

power, voltage or current value applied to the input port of a duplexer/diplexer/multiplexer

[SOURCE: IEC 60862-1:2015, 3.1.2.30, modified – In the definition, "input terminal of a filter" has been replaced with "input port of a duplexer/diplexer/multiplexer".]

3.1.2.20

output level

power, voltage or current value delivered to the load circuit

[SOURCE: IEC 60862-1:2015, 3.1.2.31]

3.1.2.21

nominal level

power, voltage or current value at which the performance measurement is specified